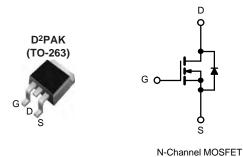


SPB73N03S2L-10-VB Datasheet N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Typ)			
30	0.0024 at V _{GS} = 10 V	98	82 nC			
	0.0027 at V _{GS} = 4.5 V	98	02 110			



FEATURES

- Trench Power MOSFET .
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2011/65/EU

APPLICATIONS

- OR-ing
- Server
- DC/DC •

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	- V		
Gate-Source Voltage	V _{GS}	± 20			
	T _C = 25 °C		98 ^{a, e}		
Continuous Drain Current (T ₁ = 175 °C)	T _C = 70 °C		98 ^e		
Continuous Drain Current $(T_j = T/5 C)$	T _A = 25 °C	I _D	28.8 ^{b, c}	Α	
	T _A = 70 °C		27 ^{b, c}	A	
Pulsed Drain Current	I _{DM} 300				
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	36		
Single Pulse Avalanche Energy	L = 0.1 MH	E _{AS}	64.8	V	
Continuous Source-Drain Diode Current	T _C = 25 °C	l.	90 ^{a, e}	А	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	3.13 ^{b, c}	A	
	T _C = 25 °C		250 ^a	w	
Mauianum Daura Diacia atian	T _C = 70 °C	P	175		
Maximum Power Dissipation	T _A = 25 °C	P _D	3.75 ^{b, c}		
	T _A = 70 °C		2.63 ^{b, c}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient ^{b, d}	$t \le 10 \text{ sec}$	R _{thJA}	32	40	°C/W		
Maximum Junction-to-Case	Steady State	R _{thJC}	0.5	0.6	0/11		

Notes:

a. Based on $T_C = 25 \text{ °C}$. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 sec.
d. Maximum under steady state conditions is 90 °C/W.
e. Calculated based on maximum junction temperature. Package limitation current is 90 A.



		I			
Symbol	Test Conditions	Min.	Тур.	Max.	Unit
1		1			
	V _{GS} = 0 V, I _D = 250 μA	30			V
$\Delta V_{DS}/T_{J}$	Iр = 250 иА		35		mV/°C
$\Delta V_{GS(th)}/T_J$	1 <u>0</u> – 200 p. (- 7.5		
V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.5		2.5	V
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
1	V _{DS} = 30 V, V _{GS} = 0 V			1	
DSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			10	μA
I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	90			A
Р	V _{GS} = 10 V, I _D = 28.8 A		0.0024		0
RDS(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 27 \text{ A}$		0.0027		Ω
9 _{fs}	V _{DS} = 15 V, I _D = 28.8 A		160		S
•					•
C _{iss}			12065		
C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		1725		pF
C _{rss}			970		
	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 28.8 A		171	257	nC
Qg	V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 28.8 A		81.5	123	
Q _{gs}			34		
Q _{gd}			29		
R _g	f = 1 MHz		1.4	2.1	Ω
t _{d(on)}			18	27	
tr	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 0.625 \Omega$		11	17	-
t _{d(off)}	$I_D \cong 24 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		70	105	
t _f			10	15	
t _{d(on)}			55	83	ns
	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 0.67 \Omega$		180	270	
	$I_D \cong 22.5 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		55	83	
	C C		12	18	
۱ _S	T _C = 25 °C			90	
I _{SM}				90	A
	I _S = 22 A		0.8	1.2	V
	~				ns
					nC
	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$				ns
t _b			25		
	$\begin{tabular}{ c c c } \hline Symbol \\ \hline \hline V_{DS} \\ \hline $\Delta V_{DS}/T_J$ \\ \hline $\Delta V_{GS}(th)/T_J$ \\ \hline $V_{GS}(th) \\ \hline I_{GSS} \\ \hline I_{DSS} \\ \hline I_{DSS} \\ \hline I_{DSS} \\ \hline $I_{D(on)}$ \\ \hline $R_{DS(on)}$ \\ \hline $R_{DS(o$	$\begin{tabular}{ c c c c } \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)}/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline V_{DS} = 0 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 10 \ V \ I_D = 28.8 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 28.8 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 28.8 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A \\ \hline \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A \\ \hline \hline Q_{gg} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A \\ \hline \hline Q_{gg} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A \\ \hline \hline Q_{gg} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 28.8 \ A \\ \hline \hline Q_{gg} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 28.8 \ A \\ \hline \hline Q_{gg} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A \\ \hline \hline Q_{gg} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A \\ \hline \hline Q_{gd} & I_T & V_{DD} = 15 \ V, \ R_L = 0.625 \ \Omega \\ \hline I_D \cong 24 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 22.5 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 22.5 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 22.5 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 22.5 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_T = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline I_{SM} & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline \hline V_{SD} & I_T = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline \hline V_{SD} & I_T = 20 \ ^{\circ}C \ V_{SD} \\ \hline \hline V_{SD} & I_T = 20 \ ^{\circ}C \ V_{SD} \\ \hline \hline V_{SD} & I_T = 20 \ ^{\circ}C \ V_{SD} \\ \hline \hline V_{SD} & I_T = 20 \ ^{\circ}C \ V_{SD} \ V_{SD} \ V_{SD} \ V_{SD} = 10 \ ^{\circ}C \ V_{SD} \ V_{SD$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A & 30 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 1.5 \\ \hline I_{DS} & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 1.5 \\ \hline V_{CS}(th) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 1.5 \\ \hline I_{DSS} & V_{DS} = 0 \ V, \ V_{GS} = 20 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 90 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ I_D = 28.8 \ A & V_{GS} = 10 \ V & 90 \\ \hline V_{GS} = 15 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS} = 15 \ V, \ V_{DS} = 10 \ V, \ I_D = 28.8 \ A & V_{DS$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 \\ \hline \Delta V_{OS}/T_J & I_D = 250 \ \mu A & 1.5 \\ \hline I_D = 250 \ \mu A & 1.5 \\ \hline V_{GS}(th) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 1.5 \\ \hline V_{DS} & V_{DS} = 0 \ V, \ V_{GS} = 4.20 \ V & 0 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \ V_{DS} = 5 \ ^{\circ}C & 0 \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V & 90 \\ \hline V_{GS} = 4.5 \ V, \ I_D = 27 \ A & 0.0027 \\ \hline g_{fS} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ I_D = 28.8 \ A & 160 \\ \hline \hline V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ I_D = 28.8 \ A & 160 \\ \hline \hline U_{Criss} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ I_D = 28.8 \ A & 171 \\ \hline Q_{g} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 28.8 \ A & 171 \\ \hline Q_{g} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 28.8 \ A & 171 \\ \hline Q_{g} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 28.8 \ A & 171 \\ \hline Q_{g} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 28.8 \ A & 171 \\ \hline Q_{1D} = 24 \ A, \ V_{GR} = 10 \ V, \ R_g = 1 \ \Omega & 29 \\ \hline R_g & f = 1 \ MHz & 1.4 \\ \hline t_{d(off)} & I_D = 24 \ A, \ V_{GR} = 10 \ V, \ R_g = 1 \ \Omega & 70 \\ \hline t_f & V_{DD} = 15 \ V, \ R_L = 0.625 \ \Omega & 11 \\ \hline I_D = 24 \ A, \ V_{GR} = 10 \ V, \ R_g = 1 \ \Omega & 70 \\ \hline t_f & 10 \\ \hline V_{DD} = 15 \ V, \ R_L = 0.67 \ \Omega & 180 \\ \hline t_{d(off)} & I_D = 22.5 \ A, \ V_{GR} = 4.5 \ V, \ R_g = 1 \ \Omega & 55 \\ \hline t_f & 12 \\ \hline S & \hline V_{SD} & I_D = 22.5 \ A, \ V_{GR} = 4.5 \ V, \ R_g = 1 \ \Omega & 55 \\ \hline t_f & V_{SD} & I_S = 22 \ A & 0.8 \\ \hline V_{SD} & I_S = 22 \ A & 0.8 \\ \hline t_{f} & I_S & T_C = 25 \ ^{\circ}C & \hline \hline T_{SM} & I_F = 20 \ A, \ di/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C & \hline T_{O.2} \\ \hline \hline T_{O.2} & T_{O.2} \\ \hline T_{O.$	$\begin{tabular}{ c c c c c c c } \hline Symbol & Test Conditions & Min. Typ. Max. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 & -7.5 & -7$

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

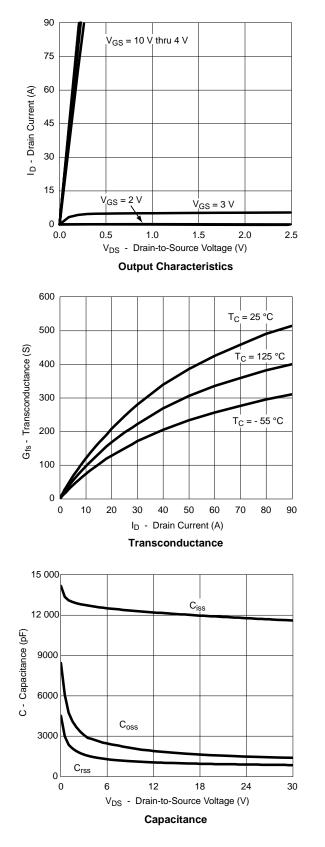
b. Guaranteed by design, not subject to production testing.

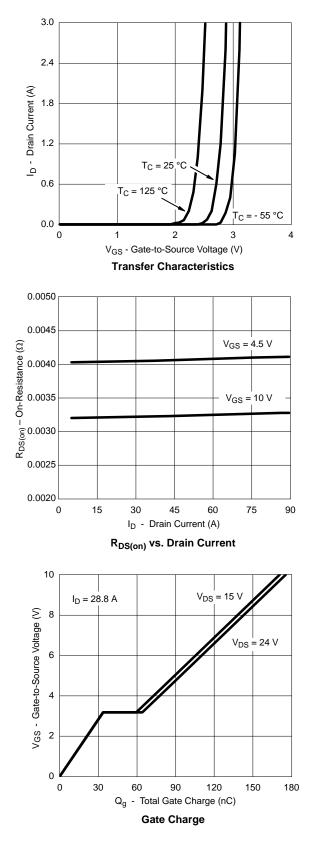
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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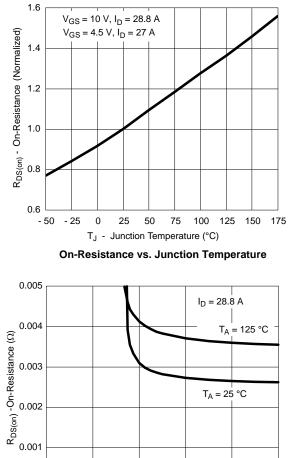
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

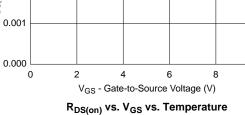


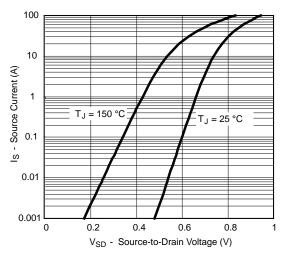




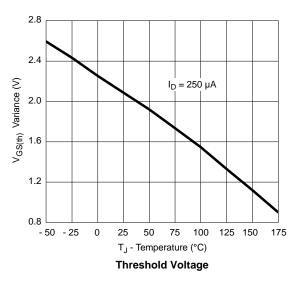
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

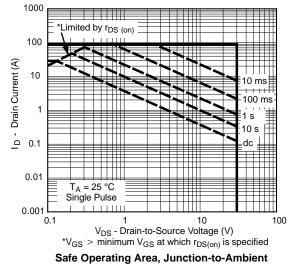






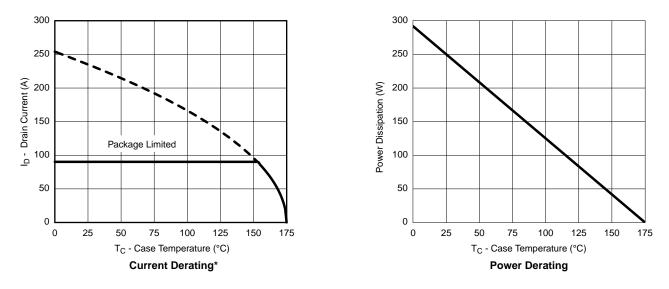
Forward Diode Voltage vs. Temperature





10





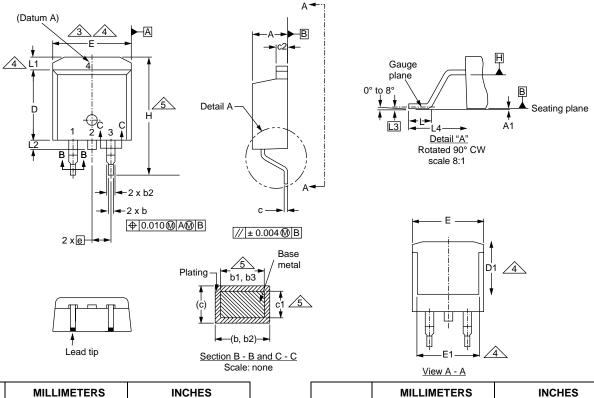
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

*The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





TO-263AB (HIGH VOLTAGE)



	MILLIMETERS		INCHES			MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MAX
А	4.06	4.83	0.160	0.190	D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010	E	9.65	10.67	0.380	0.420
b	0.51	0.99	0.020	0.039	E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035	е	2.54 BSC		0.100 BSC	
b2	1.14	1.78	0.045	0.070	Н	14.61	15.88	0.575	0.625
b3	1.14	1.73	0.045	0.068	L	1.78	2.79	0.070	0.110
С	0.38	0.74	0.015	0.029	L1	-	1.65	-	0.066
c1	0.38	0.58	0.015	0.023	L2	-	1.78	-	0.070
c2	1.14	1.65	0.045	0.065	L3	0.25 BSC		0.010 BSC	
D	8.38	9.65	0.330	0.380	L4	4.78	5.28	0.188	0.208

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

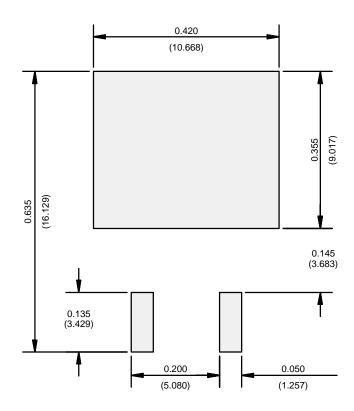
5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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